

Using LMZ31520EVM-001, LMZ31530EVM-002 Evaluation Module

User's Guide



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LMZ31520EVM-001 & LMZ31530EVM-002, 20-A & 30-A Simple Switcher® Power Module

The LMZ31520/30 EVM is designed as an easy to use platform that facilitates evaluation of the features and performance of the Simple Switcher® power module. The LMZ31520 and LMZ31530 devices provide output currents of 20A and 30A, respectively. This guide provides information on the correct usage of the EVM and an explanation of the various test points found on the board.

1 Description

The EVM features a LMZ31520 (20A) or LMZ31530 (30A), synchronous buck Simple Switcher® power module configured for operation with typical 5-V and 12-V input bus applications. The output voltage can be set to one of six popular values by using a configuration jumper. In similar fashion, the switching frequency can be set to one of four values with a jumper. The full 20-A / 30-A rated output current can be supplied by the EVM. Input and output capacitors are included on the board to accommodate the entire range of input and output voltages. Monitoring test points are provided to allow measurement of efficiency, power dissipation, input ripple, output ripple, line and load regulation, and transient response. Control test points are provided for use of the PWRGD and Inhibit features of the power module along with a selector for Eco-Mode or FCCM. The EVM uses a recommended PCB layout that maximizes thermal performance and minimizes output ripple and noise.

2 Getting Started

Figure 1 highlights the user interface items associated with the EVM. The polarized *PVin* Power terminal block (J8) is used for connection to the host input supply and the polarized *Vout* Power terminal block (J11) is used for connection to the load. These terminal blocks can accept up to 16-AWG wire. The polarized *VBIAS* terminal block (J12) is used along with the VIN SELECT jumper (J4) when optional split power supply operation is desired. Refer to the LMZ31520/30 datasheet for further information on split power supply operation.

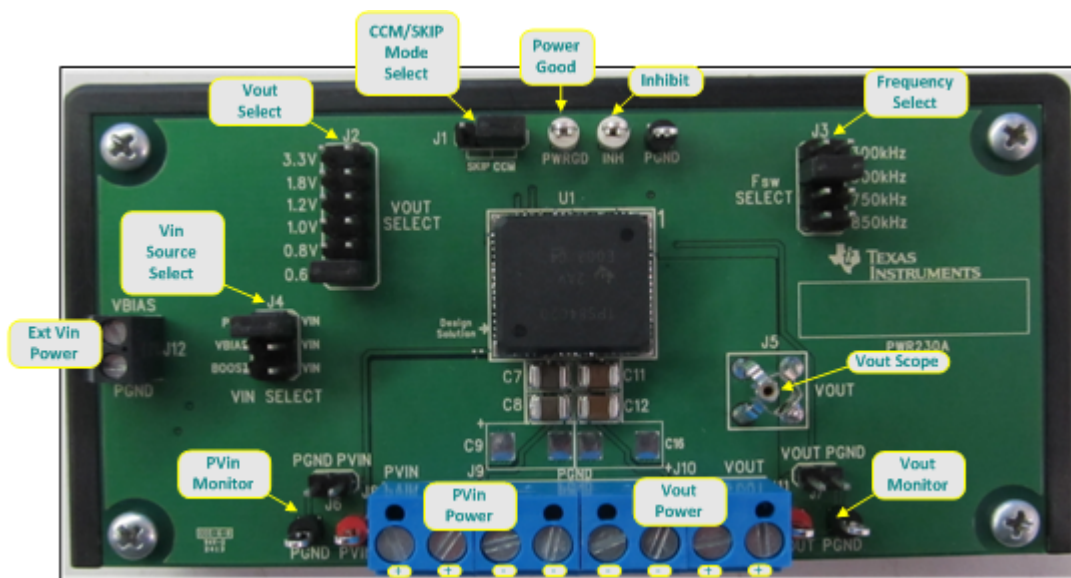


Figure 1. LMZ31520/30EVM User Interface

The *PVin Monitor* (TP1) and *Vout Monitor* (TP3) test points located near the power terminal blocks are intended to be used as voltage monitoring points where voltmeters can be connected to measure PVin and Vout. The voltmeter references should be connected to the PGND test points (TP4 & TP2). Do *not* use these PVin and Vout monitoring test points as the input supply or output load connection points. The PCB traces connecting to these test points are not designed to support high currents.

The *PVin Scope* (J6) and *Vout Scope* (J7) test points can be used to monitor PVin and Vout waveforms with an oscilloscope. These test points are intended for use with un-hooded scope probes outfitted with a low-inductance ground lead (ground spring) mounted to the scope barrel. The two sockets of each test point are on 0.1 inch centers. The scope probe tip should be connected to the socket labeled PVin or Vout, and the scope ground lead should be connected to the socket labeled PGND.

The *Vout Scope* (J5) test point can be used to monitor the Vout waveform with an oscilloscope. This test point is intended for use with an un-hooded scope probe with a 3.5 mm ground barrel.

The control test points located directly above the device are made available to test the features of the device. Refer to the [Test Points Descriptions](#) section of this guide for more information on the individual control test points.

The *Vout Select* jumper (J2) and *Fsw Select* jumper (J3) are provided for selecting the desired output voltage and appropriate switching frequency. Before applying power to the EVM, ensure that the jumpers are present and properly positioned for the intended output voltage. Always remove input power before changing the jumper settings.

3 Test Point Descriptions

Seven wire-loop test points and three scope probe test points have been provided as convenient connection points for digital voltmeters (DVM) or oscilloscope probes to aid in the evaluation of the device. A description of each test point follows:

Table 1. Test Point Descriptions⁽¹⁾

PVIN	Input voltage monitor. Connect DVM to this point for measuring efficiency.
VOUT	Output voltage monitor. Connect DVM to this point for measuring efficiency, line regulation, and load regulation.
PGND	Input and output voltage monitor grounds. Reference the above DVMs to the corresponding ground point.
PVIN Scope (J6)	Input voltage scope monitor. Connect an oscilloscope to this set of points to measure input ripple voltage.
VOUT Scope (J7)	Output voltage scope monitor. Connect an oscilloscope to this set of points to measure output ripple voltage and transient response.
VOUT Scope (J5)	Output voltage scope monitor. Insert an oscilloscope into the test point adapter to measure output ripple voltage and transient response.
PWRGD	Monitors the power good signal of the device. A 100-kΩ pullup resistor is included internal to the device and is tied to 5V. PWRGD is high if the output voltage is within 95% to 110% of its nominal value.
INH	Connect this point to control ground to inhibit the device. Allow this point to float to enable the device.

⁽¹⁾ Refer to the product datasheet for absolute maximum ratings associated with above features.

4 Operation Notes

In order to operate the EVM using a single power supply, the Vin Select jumper (J4) must be in the default PVIN-VIN position shown in [Figure 1](#). In this position, the PVin and Vin pins of the device are connected together. The UVLO threshold of the EVM is approximately 4.2 V with 0.25 V of hysteresis. The input voltage must be above the UVLO threshold in order to startup the device. After startup, the minimum input voltage to the device must be at least 4.5 V or (Vout + 1.0 V), whichever is greater. The maximum operating input voltage for the device is 15 V. Refer to the product datasheet for further information on the input voltage range, and optional split power supply operation for operating with PVin as low as 3.0 V when using an external Vbias supply.

After application of the proper input voltage, the output voltage of the device will ramp to its final value in approximately 0.7 ms. If desired, this soft-start time can be increased by increasing the value of the R_{ss} resistor (R6). Refer to the LMZ31520/30 datasheet for further information on adjusting the soft-start time.

The EVM includes input and output capacitors to accommodate the entire range of input and output voltage conditions. The actual capacitance required will depend on the input and output voltage conditions of the particular application, along with the desired transient response. In most cases, the required output capacitance will be less than that supplied on the EVM. Refer to the LMZ31520/30 datasheet for further information on the minimum required I/O capacitance and transient response.

The LMZ31520/30 can be operated in either Auto-skip Eco-Mode or in Forced Continuous Conduction Mode (FCCM) by selecting the desired mode using J1. Refer to the LMZ31520/30 datasheet for further information on selecting the mode of operation.

5 Performance Data

Figure 2 through Figure 8 demonstrate the TPS84A20EVM performance with $V_{out} = 1.8\text{ V}$ and $f_{sw} = 500\text{ kHz}$

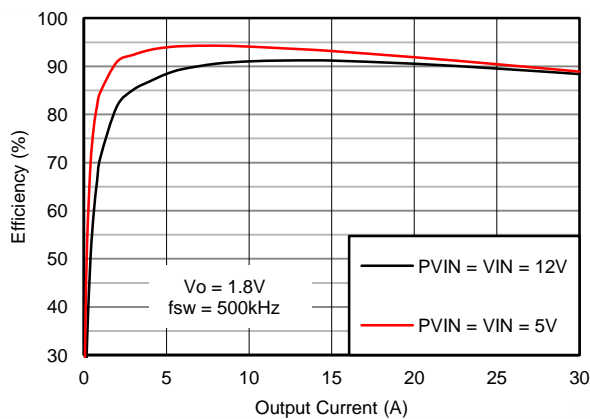


Figure 2. LMZ31530EVM Efficiency

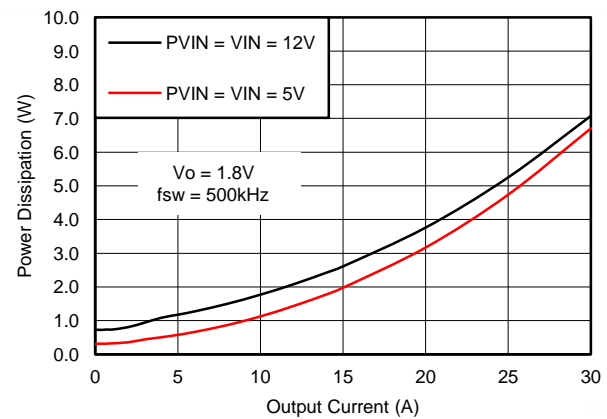


Figure 3. LMZ31530EVM Power Dissipation

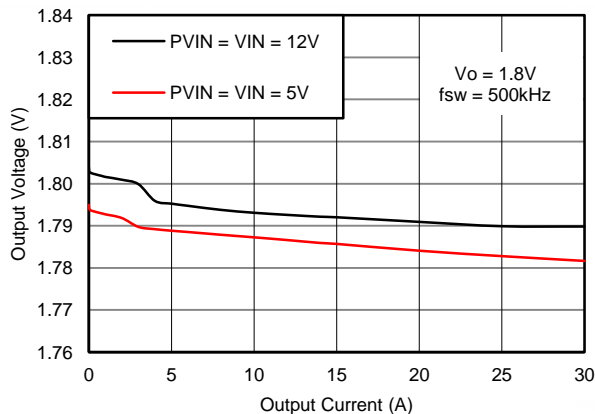


Figure 4. LMZ31530EVM Load Regulation

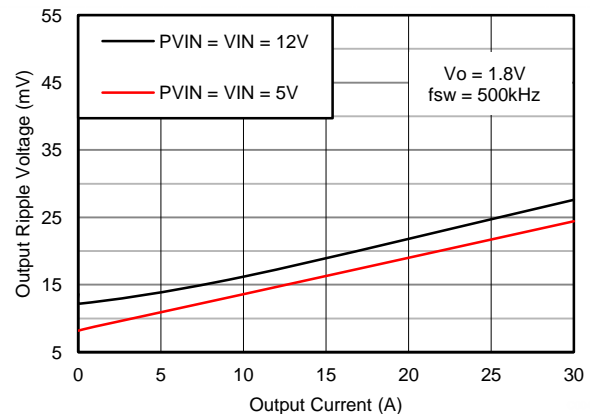


Figure 5. LMZ31530EVM Output Ripple

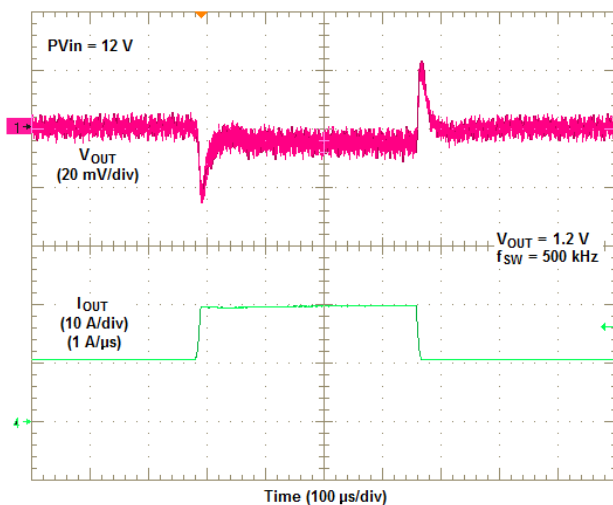


Figure 6. LMZ31530EVM Transient Response Waveforms

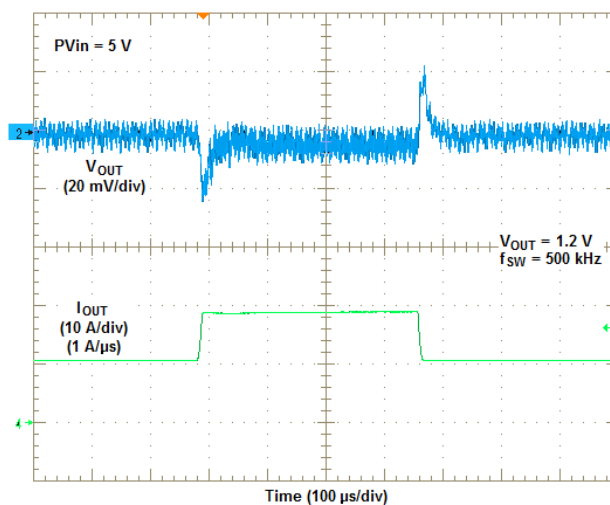


Figure 7. LMZ31530EVM Transient Response Waveforms

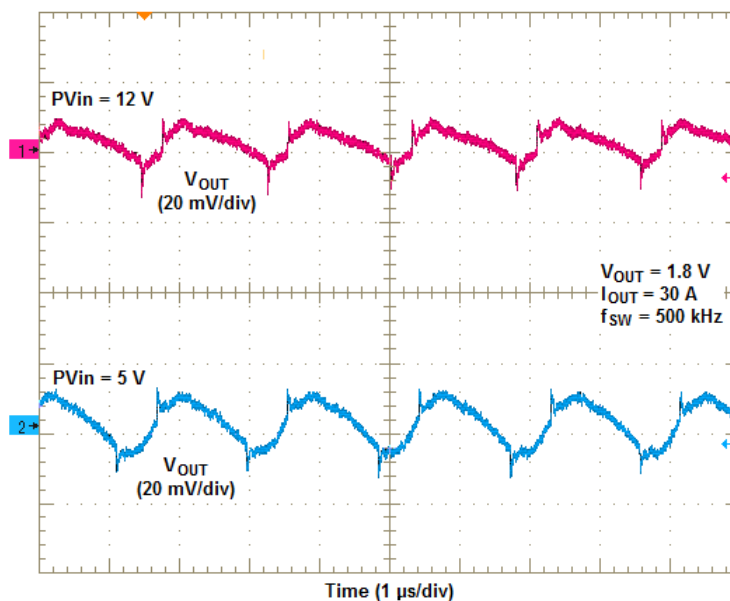
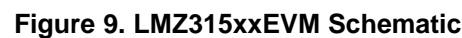


Figure 8. LMZ31530EVM Output Ripple Waveforms

Figure 9 is the schematic for this EVM.



7 Bill of Materials

Figure 10 is the BOM for the EVM.

COUNT		RefDes	Value	Description	Size	Part Number	Mfr
-002	-001						
3	3	C1, C2, C3	33uF	Capacitor, Ceramic, 25V, X5R, 20%	1206	C3216X5R1E336M160AC	TDK Corporation
5	5	C4, C5, C6, C7, C8	47uF	Capacitor, Ceramic, 16V, X5R, 10%	1210	EMK325BJ476MM-T	Taiyo Yuden
2	2	C9, C10	22uF	Capacitor, Polymer, 16V, 20%	2917	A700D226M016ATE018	Kemet
5	5	C11, C12, C13, C14, C15	100uF	Capacitor, Ceramic, 6.3V, X5R, 20%	1210	C3225X5R0J107M250AC	TDK Corporation
2	2	C16, C17	330uF	Capacitor, Polymer, 4V, 20%	2917	EEF-UE0G331R	Panasonic
1	1	C18	1uF	Capacitor, Ceramic, 6.3V, X5R, 10%	0603	C1608X5R0J105K	TDK Corporation
2	2	C19, C20	2.2uF	Capacitor, Ceramic, 6.3V, X5R, 10%	0805	C2012X5R0J225M085AA	TDK Corporation
1	1	C21	1uF	Capacitor, Ceramic, 6.3V, X5R, 10%	0805	C0805C105K9PACTU	Kemet
2	2	C22, C23	1uF	Capacitor, Ceramic, 25V, X5R, 10%	0805	C2012X5R1E105K085AC	TDK Corporation
1	1	J1	PEC03SAAN	Header, Male, 1x3 pin, 0.1" centers	0.100 inch x 1 x 3	PEC03SAAN	Sullins
1	1	J2	PEC06DAAN	Header, Male, 2x6 pin, 0.1" centers	0.100 inch x 2 x 6	PEC06DAAN	Sullins
1	1	J3	PEC04DAAN	Header, Male, 2x4 pin, 0.1" centers	0.100 inch x 2 x 4	PEC04DAAN	Sullins
1	1	J4	PEC03DAAN	Header, Male, 2x3 pin, 0.1" centers	0.100 inch x 2 x 3	PEC03DAAN	Sullins
1	1	J5	131-5031-00	CB TEST POINT ADAPTER, 5mm	0.690 x 0.690 inch	131-5031-00	Tektronix
2	2	J6, J7	PEC02SAAN	Header, Male, 1x2 pin, 0.1" centers	0.100 inch x 1 x 2	PEC02SAAN	Sullins
4	4	J8, J9, J10, J11	ED120/2DS	Terminal Block, 2-pin, 15A, 5.1mm	0.40 x 0.35 inch	ED120/2DS	On Shore Technology
1	1	J12	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	3.5 mm x 1 x 2	ED555/2DS	On Shore Technology
1	1	R1	4.32k	Resistor, Chip, 1/16W, 1%	0603	CRCW06034K32FKEA	Vishay Dale
1	1	R2	2.15k	Resistor, Chip, 1/16W, 1%	0603	CRCW06032K15FKEA	Vishay Dale
1	1	R3	1.43k	Resistor, Chip, 1/16W, 1%	0603	CRCW06031K43FKEA	Vishay Dale
1	1	R4	715	Resistor, Chip, 1/16W, 1%	0603	CRCW0603715RFKEA	Vishay Dale
1	1	R5	316	Resistor, Chip, 1/16W, 1%	0603	CRCW0603316RFKEA	Vishay Dale
3	3	R6, R10, R11	0	Resistor, Chip, 1/16W, 1%	0603	ERJ-3GEY0R00V	Panasonic
1	1	R7	187k	Resistor, Chip, 1/16W, 1%	0603	CRCW0603187KFKEA	Vishay Dale
1	1	R8	66.5k	Resistor, Chip, 1/16W, 1%	0603	CRCW060366K5FKEA	Vishay Dale
0	0	R9	optional (user-defined)	Resistor, Chip, 1/16W, 1%	0402	optional (user-defined)	optional (user-defined)
1	1	R12	10	Resistor, Chip, 1/16W, 1%	0603	CRCW060310R0FKEA	Vishay Dale
2	2	TP1, TP3	5010	Test Point, Red, Wire Loop, Thru Hole	0.125 x 0.125 inch	5010	Keystone
3	3	TP2, TP4, TP7	5011	Test Point, Black, Wire Loop, Thru Hole	0.125 x 0.125 inch	5011	Keystone
2	2	TP5, TP6	5012	Test Point, White, Wire Loop, Thru Hole	0.125 x 0.125 inch	5012	Keystone
0	1	U1	LMZ31520RLG	IPS, Sync Buck, 3 to 14.5V Input, 30A Output	15x16x5.8 mm QFN	LMZ31520RLG	TI
1	0	U1	LMZ31530RLG	IPS, Sync Buck, 3 to 14.5V Input, 20A Output	15x16x5.8 mm QFN	LMZ31530RLG	TI
1	1	U2	TPS60150DRV	150mA 5V charge pump	2x2x0.8 mm QFN	TPS60150DRV	TI
1	1	U3	TLV70450DBV	24-V Input, 150 mA, 5.0V LDO Regulator	3x3x1.45 mm SOT-23	TLV70450DBV	TI
4	4	---	---	Shunt, Black	0.100 inch x 1 x 2	929950-00	3M
4	4	---	---	Bumpon, Hemisphere, Black	0.44 Dia. x 0.20 inch	SJ-5003	3M
1	1	---	---	PCB, 2" x 4" x 0.062"	2 x 4 x 0.062 inch	PWR203	Any
1	1	---	---	Label	1.25 x 0.25 inch	THT-13-457-10	Brady

Figure 10. LMZ315x0EVM BOM

Figure 11 through Figure 18 show the PCB layout layers of the EVM.



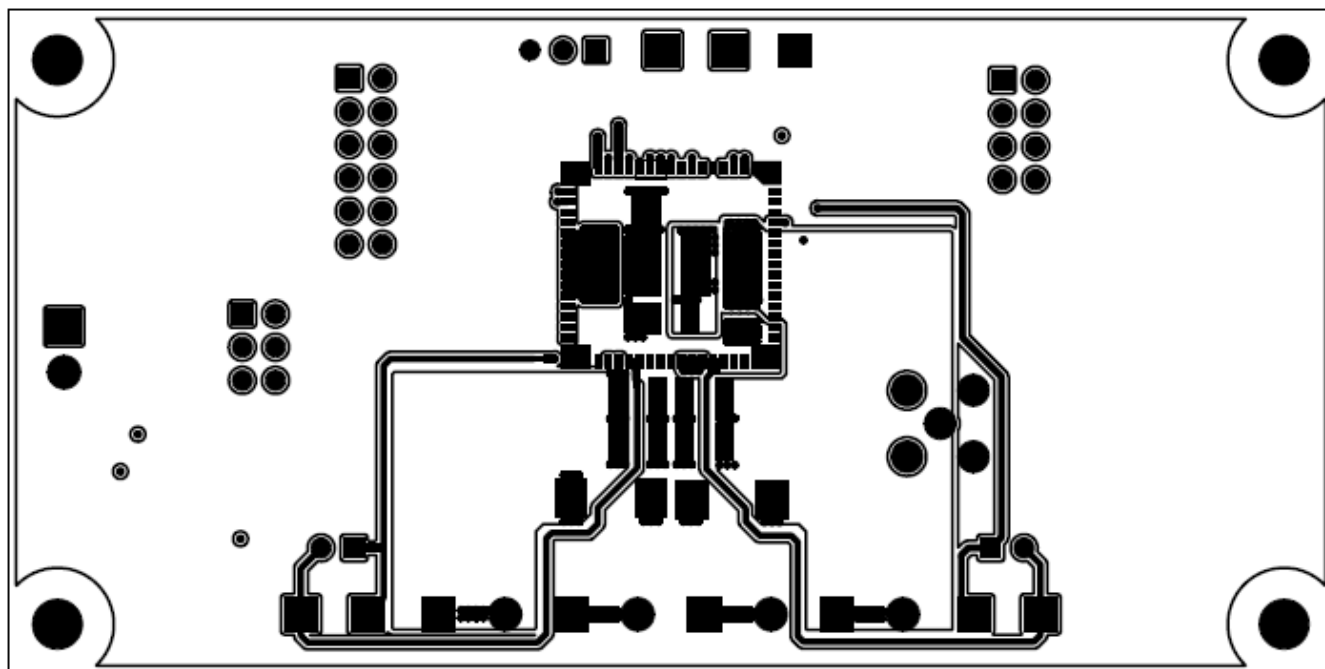


Figure 13. EVM Top Side Copper

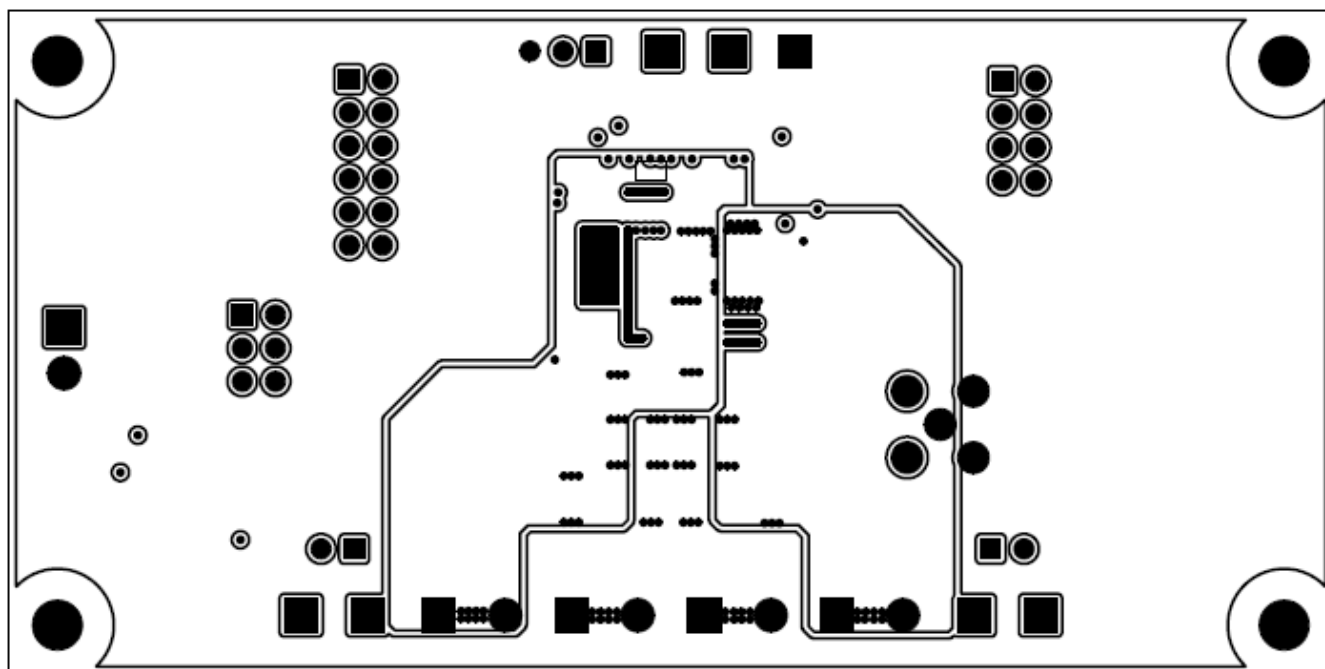


Figure 14. EVM Layer 2 Copper

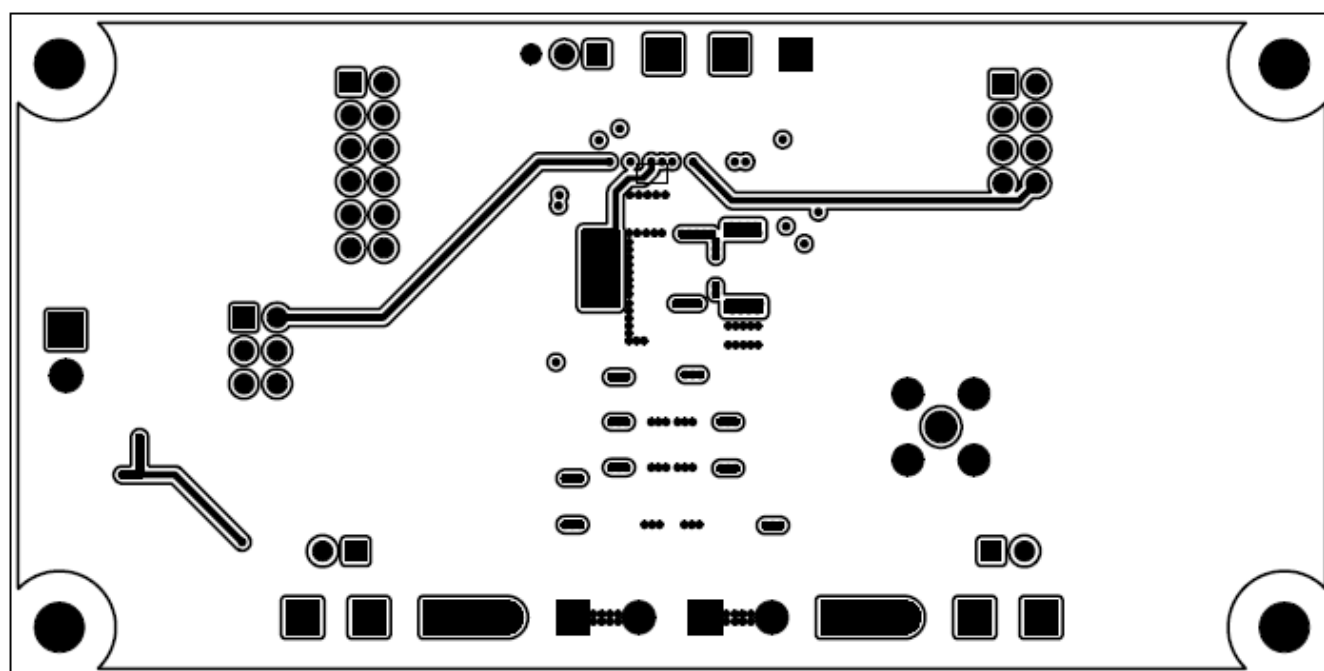


Figure 15. EVM Layer 3 Copper

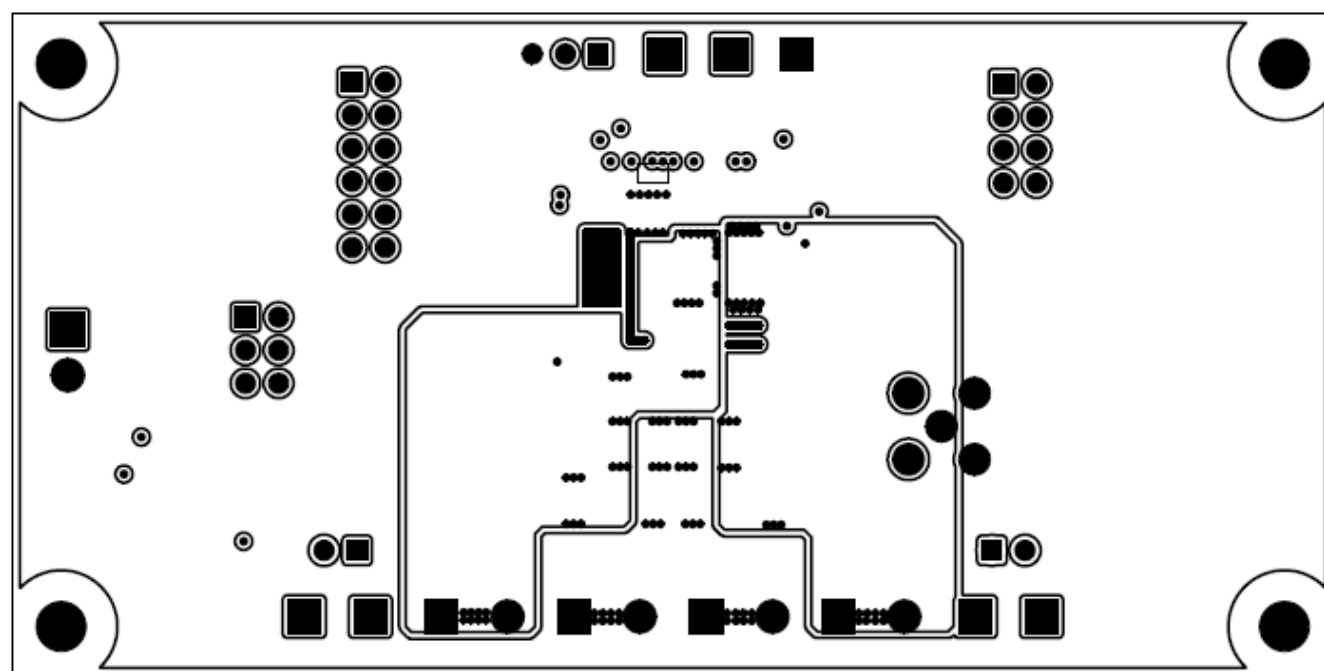


Figure 16. EVM Layer 4 Copper

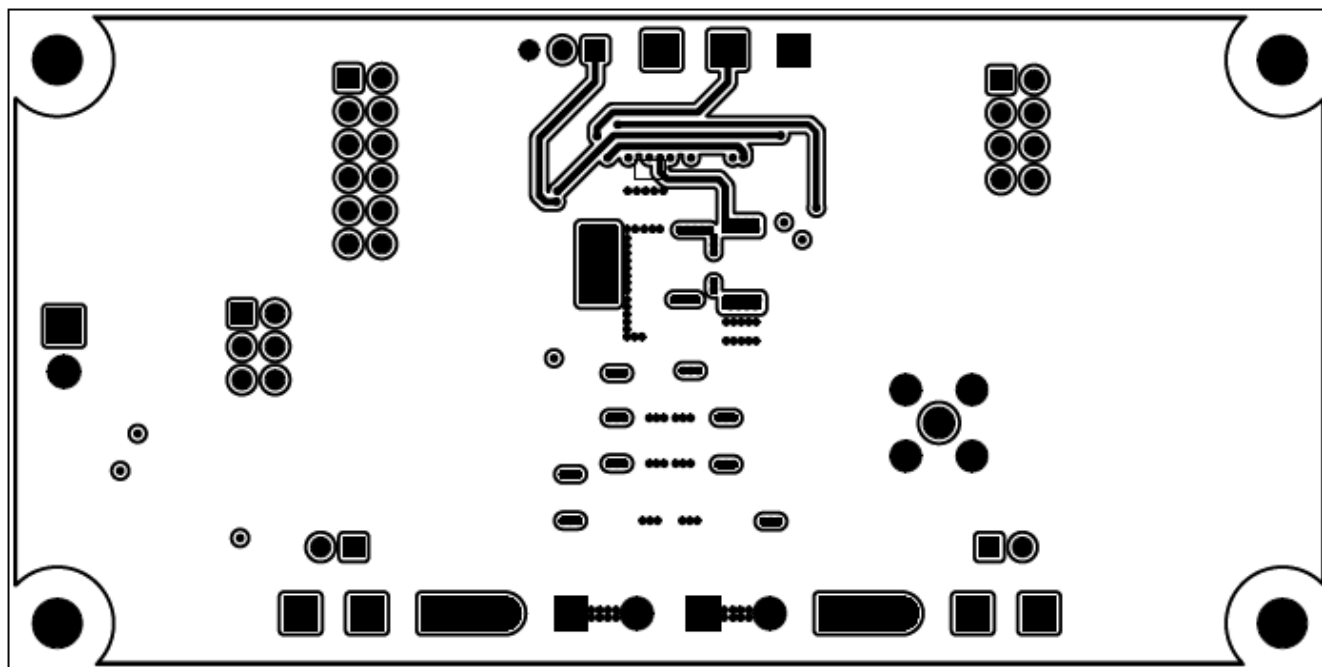


Figure 17. EVM Layer 5 Copper

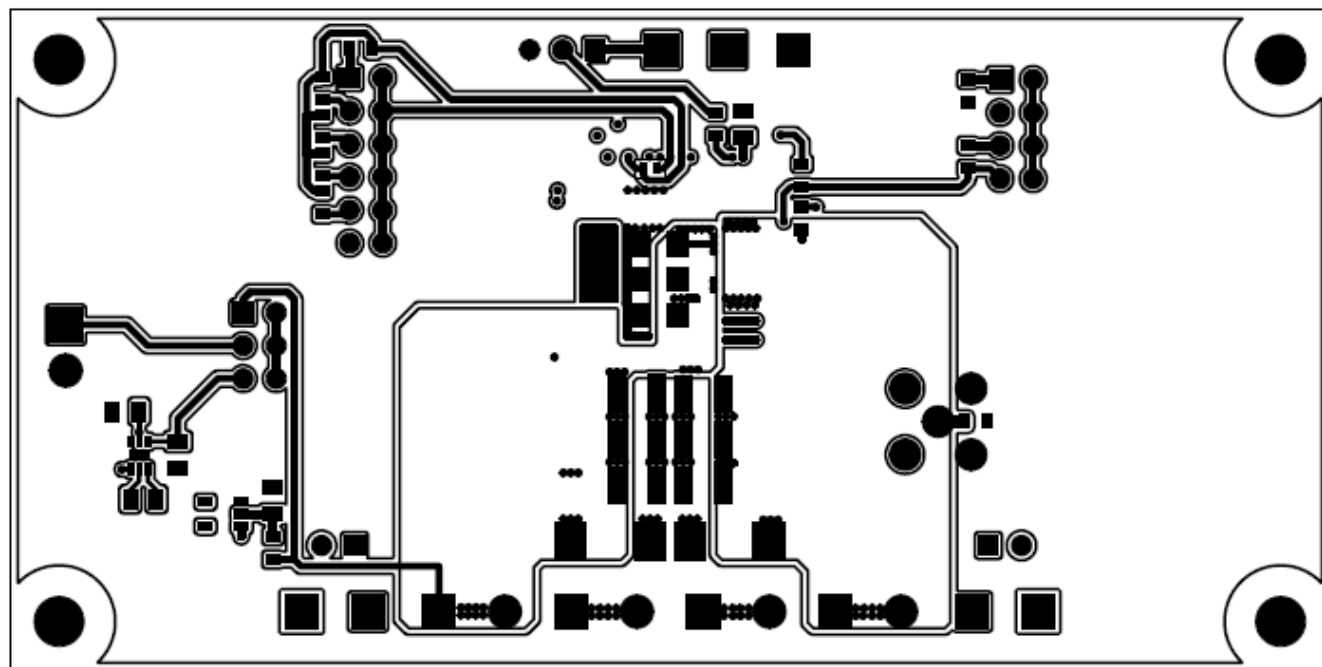


Figure 18. EVM Bottom Side Copper

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As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

【Important Notice for Users of EVMs for RF Products in Japan】

This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. Since the EVM is not a completed product, it may not meet all applicable regulatory and safety compliance standards (such as UL, CSA, VDE, CE, RoHS and WEEE) which may normally be associated with similar items. You assume full responsibility to determine and/or assure compliance with any such standards and related certifications as may be applicable. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

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